

Attorney Docket:
54364

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gupta, et al
For: Method for Bonding Wafers to Produce
Stacked Integrated Circuits

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Calvin B. Ward

Signature of person mailing

JC872 U.S. PTO
09/847667

05/01/01

PATENT APPLICATION

Hon. Commissioner of Patents and Trademarks
Washington, D.C. 20231

Sir:

The following documents are transmitted herewith:

(X) original patent application. (X) Utility () Design () continuation-in-part application.

- (X) The Declaration and Power of Attorney. (X) signed () unsigned or partially signed
(X) 8 sheets of (X) formal drawings () informal drawings
(X) Applicant is a small entity

(X) A check in the amount of \$355 to cover the filing fee is enclosed.

Applicants believe that no additional fee is required. However, the Commissioner is hereby authorized to charge any additional fees which may be required in this application under 37 C.F.R. Section 1.16-1.17 during its entire pendency, or credit any overpayment, to Deposit Account No. 23-0424. Should no proper payment be enclosed herewith, as by a check being in the wrong amount, unsigned, post-dated, otherwise improper or informal or even entirely missing, the Commissioner is authorized to charge the unpaid amount to Deposit Account No. 23-0424. This sheet is filed in duplicate.

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